

# **Customer Information Notification**

202402024 : SJA1105PQRS Datasheet Update

**Note:** This notice is NXP Company Proprietary.

Issue Date: Mar 04, 2024 Effective date: Apr 04, 2024

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## **Management summary**

SJA1105PQRS datasheet update

### **Change Category**

[]Wafer Fab Process	[]Assembly Process	[]Product Marking	[]Test Process	[]Design
[]Wafer Fab Materials	[ ]Assembly Materials	[]Mechanical Specification	[]Test Equipment	[]Errata
[]Wafer Fab Location	[]Assembly Location	[]Packing/Shipping/Labeling	[]Test Location	[ ]Electrical spec./Test coverage
	D 43 O 41			

[]Firmware [X]Other: Datasheet update

# **PCN Overview**

# **Description**

For Product Line In-Vehicle Networking (PL IVN) the datasheet of product SJA1105PQRS has been updated, with clarifications on:

- Applicability of RGMII-ID support to only 1000 Mbit/s
- Thermal characteristics as they have always been applicable (incorrect numbers provided in previous revision datasheet)

Lastly, a number of editorial changes have been made.

The datasheet's revision history specifies the updates.

Note that no change whatsoever has been made to the product, this announcement is purely about a datasheet update.

Attached to this Customer Information Notification (CIN) are three additional documents:

- The new SJA1105PQRS datasheet, which will also be published on the NXP website (www.nxp.com) one month after the distribution of this CIN to customers
- The ZVEI Delta Qualification Matrix (DeQuMa) for this datasheet update, both in zipped excel and pdf format. The applicable change ID numbers are SEM-DS-01 and SEM-DS-02

See the paragraphs 'Additional information' and 'Remarks' below for instructions on how to obtain these documents

### Reason

NXP PL IVN wants to properly inform you of the updated datasheet specifications for the SJA1105PQRS product.

### **Identification of Affected Products**

Product identification does not change

## Anticipated Impact on Form, Fit, Function, Reliability or Quality

There is no impact on form, fit, function, reliability or quality, other than the intended updated datasheet specifications.

### **Data Sheet Revision**

A new datasheet will be issued

## Additional information

Additional documents: view online

## Remarks

Please use the link 'view online' under the heading 'Additional information' above, to log in to the NXP e-PCN system you're subscribed to, in order to obtain the attached document with relevant detailed information from the tab 'Files'.

Should you not be able to obtain this document, please contact your NXP sales representative or the e-mail address mentioned below under 'Contact and Support'.

In the NXP e-PCN system on the tab 'Products' you can see a list of your affected part numbers.

# **Contact and Support**

For all inquiries regarding the ePCN tool application or access issues, please contact NXP "Global Quality Support Team".

For all Quality Notification content inquiries, please contact your local NXP Sales Support team.

For specific questions on this notice or the products affected please contact our specialist directly:

Name Kees van Hasselt

Position Quality Account Manager

e-mail

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NXP Quality Management Team.

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NXP Semiconductors

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Orderable Part Number#	12NC	Product Type	Product Description	Package Outline	Package Description	Product Status	Customer Specific Indicator	Product Line
SJA1105PELY	935309153518	SJA1105PEL	SWITCH ETHERNET	(L)FBGA159M	SOT1427-1	RFS	No	BLC1
SJA1105QELY	935309154518	SJA1105QEL	SWITCH ETHERNET	(L)FBGA159M	SOT1427-1	RFS	No	BLC1
SJA1105RELY	935309155518	SJA1105REL	SWITCH ETHERNET	(L)FBGA159M	SOT1427-1	RFS	No	BLC1
SJA1105SELY	935309156518	SJA1105SEL	SWITCH ETHERNET	(L)FBGA159M	SOT1427-1	RFS	No	BLC1